

Specification Sheet: Ultra Violet LED Chip

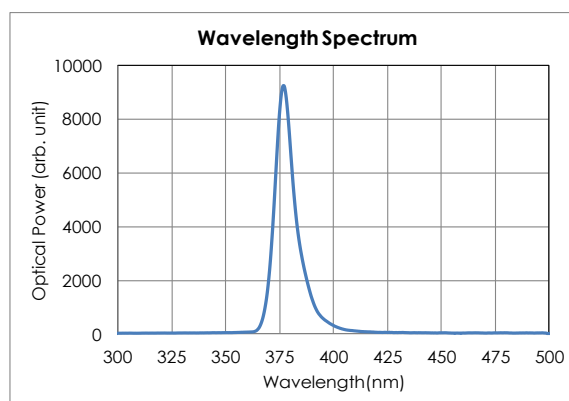
Model: UC6060F10-A1

1) Optical and Electrical Characteristics (Ta=25°C)

Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	VF1	If=350mA	-	3.2	3.4	V
Reverse Current	Ir	Vr=-5V	-	-	10	uA
Peak Wavelength	WP	If=350mA	370		380	nm
Optical Power	IV	If=350mA	Refer to Rank Information			mW

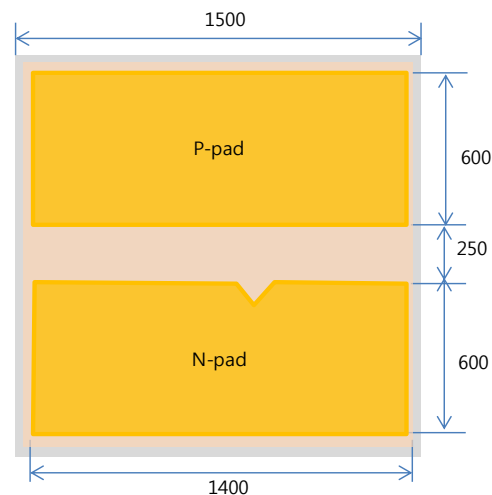
2) Rank Information (Bin Table)

Po (Optical Power)			
BIN	Min	Typ.	Max.
100	100	-	125
125	125	-	150
150	150	-	175
175	175	-	200



3) Description

Description	Dimension	Material
Chip Size (um)	1500 x 1500 ±30	
Emission Area (um)	1445 x 1445 ±30	GaN Based Material
Chip Thickness (um)	150 ±20	
P Bonding Pad (um)	1400 x 600 ± 15	Au
N Bonding Pad (um)	1400 x 600 ± 15	Au



4) Caution

- Don't look directly into the LED light. UV radiation can harm your eyes.
- To prevent even inadequate exposure, wear protective eyewear.
- If LEDs are embedded in devices, please indicate warning labels against the UV light LED used.
- LED chips are very sensitive to static and surge. All equipment and human bodies must be properly grounded.
- LED chips should be stored at normal temperature (15 ~ 35°C) and humidity(45 ~ 70%). LED chips can be stored for maximum 3 months.



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